

Tops 5 Power Pure White LED

OSW4XAH5E1E

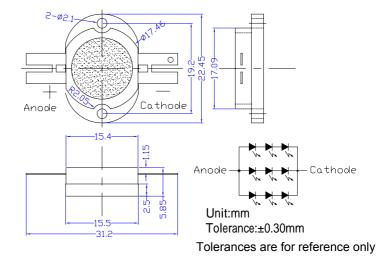
VER.1

Features

•Outline Dimension

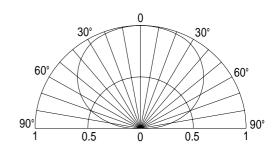
- High-power LED
- Long lifetime operation •
- Typical viewing angle : 140deg
- **RoHS** compliant •
- Possible to attach to heat sink directly without using print circuit board.
- **Applications**
- Indoor & outdoor lighting
- Stage lighting
- Reading lamps
- Display cases, furniture illumination, marker •
- Architectural illumination
- Spotlights

Absolute Maximum Rating



Directivity

Absolute Maximum Rating		(Ta=25)		
Item	Symbol	Value	Unit	
DC Forward Current *1	I _F	600	mA	
Pulse Forward Current*2	I_{FP}	1,000	mA	
Reverse Voltage	V _R	15	V	
Power Dissipation*1	P _D	6,840	mW	
Operating Temperature	Topr	-30 ~ +85		
Storage Temperature	Tstg	-40~ +100		
Lead Soldering Temperature	Tsol	260 /5sec	-	



*1, Power dissipation and forward current are the value when the module temperature is

set lower than the rating by using an adequate heat sink.

*2, Pulse width Max.10ms Duty ratio max 1/10

Symbol	Condition				
	Condition	Min.	Тур.	Max.	Unit
$V_{\rm F}$	I _F =500mA	8.7	10	11.4	V
I _R	V _R =15V	-	-	30	μA
v	I _F =500mA	350	410	-	lm
CCT	I _F =500mA	-	6500	-	Κ
х	I _F =500mA	-	0.31	-	
у	I _F =500mA	-	0.34	-	
201/2	I _F =500mA	-	140	-	deg
	I _R V CCT x y 2θ1/2	$\begin{tabular}{ c c c c c } \hline I_{R} & V_{R} = 15V \\ \hline V & I_{F} = 500 \text{mA} \\ \hline CCT & I_{F} = 500 \text{mA} \\ \hline x & I_{F} = 500 \text{mA} \\ \hline y & I_{F} = 500 \text{mA} \\ \hline \end{tabular}$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$

Note: Don't drive at rated current more than 5s without heat sink for High Power series.

* Tolerance of chromaticity coordinates is $\pm 10\%$,

* Tolerance of Luminous Flux is +20%

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as a prerequisite on design process of 5W LED.

Heat design

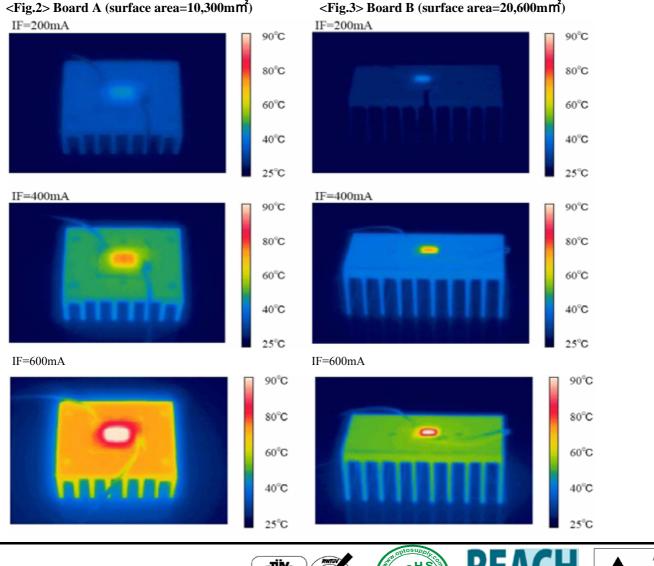
The following pictures show some measurements of mounted 5W Led on the heat sink for each board A and B (See Fig 1) with using thermograph to make an observation about heat distribution. Each boards is tested at various current conditions. As a result, LED needs larger heat sink as much as possible to reduce its own case temperature.

rig. 1 Configuration pattern examples for board assembly						
Board	LED power	Material	Surface area (mm²) Min.			
А	5W	Al	10,300			
В	10W	Al	20,600			
С	25W	Al	51,500			
D	50W	Al	103,000			
Е	100W	Al	206,000			
F	200W	Al	412,000			
G	300W	Al	618,000			

Fig. 1 Configuration pattern examples for board assembly

Above tested LED device is attached with adhesive sheet to the heatsink.

For reference's sake, Tj absolute maximum rating is defined at 115



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